



FIG. 1A

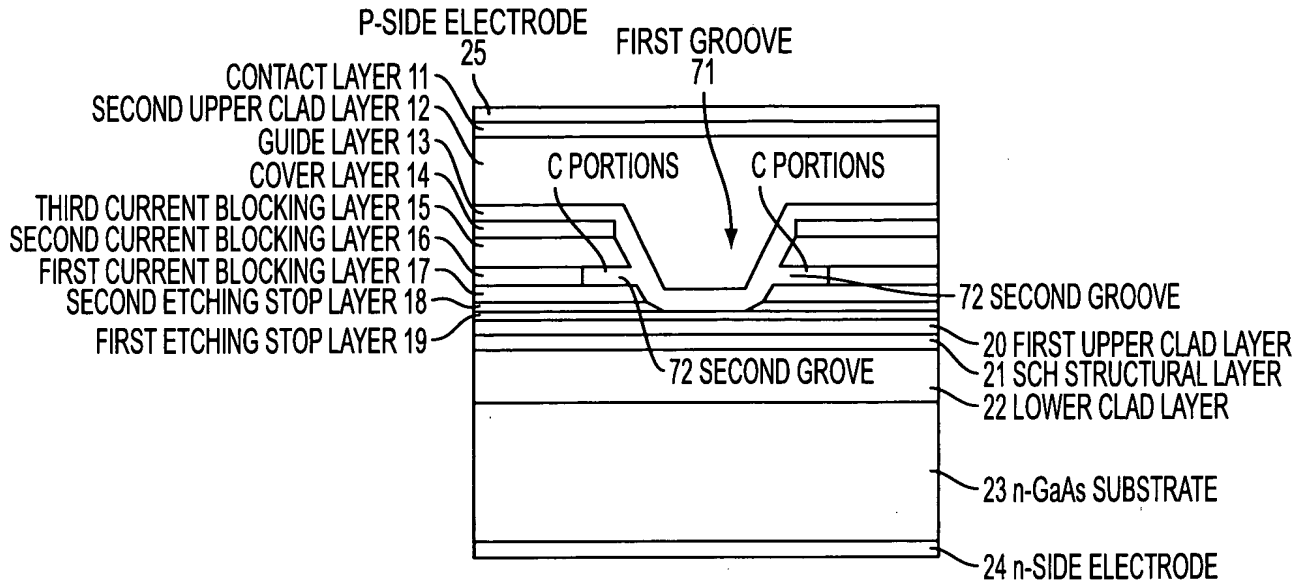


FIG. 1B

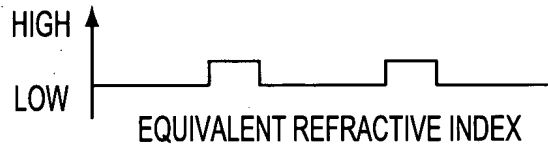
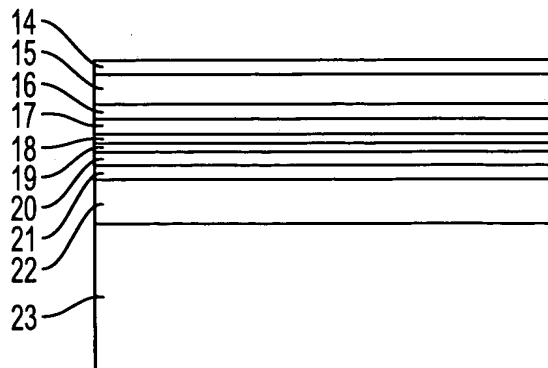


FIG. 2



RECEIVED
 DEC 16 2003
 TECHNOLOGY CENTER 2800



FIG. 7A

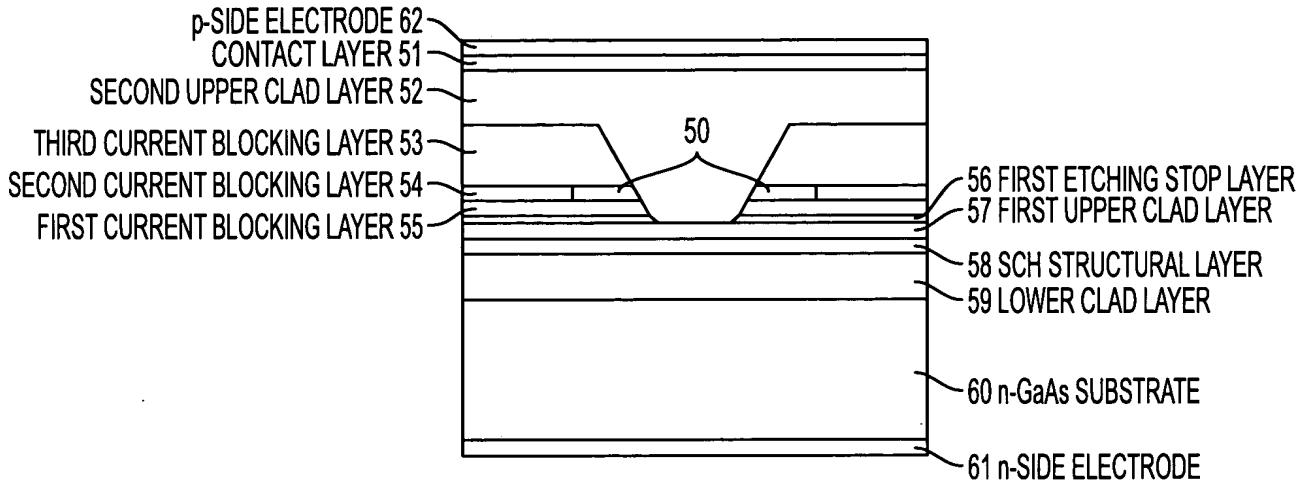


FIG. 7B

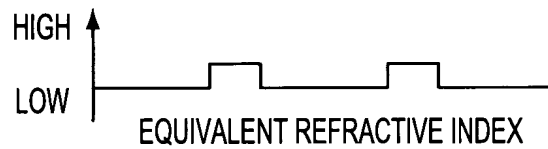


FIG. 8

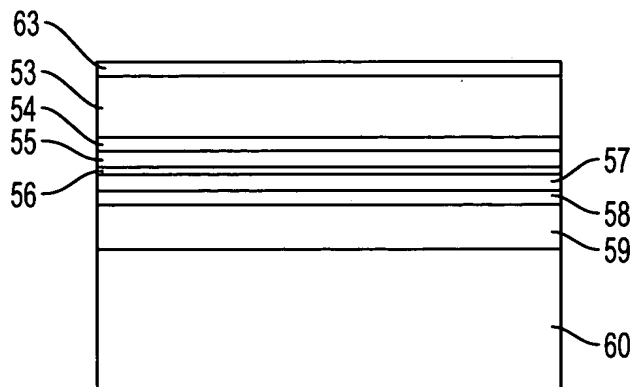




FIG. 12

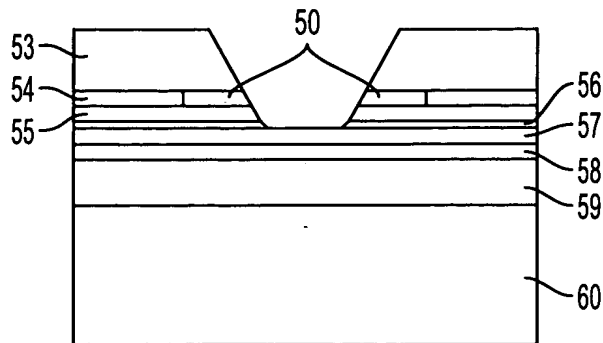


FIG. 13A

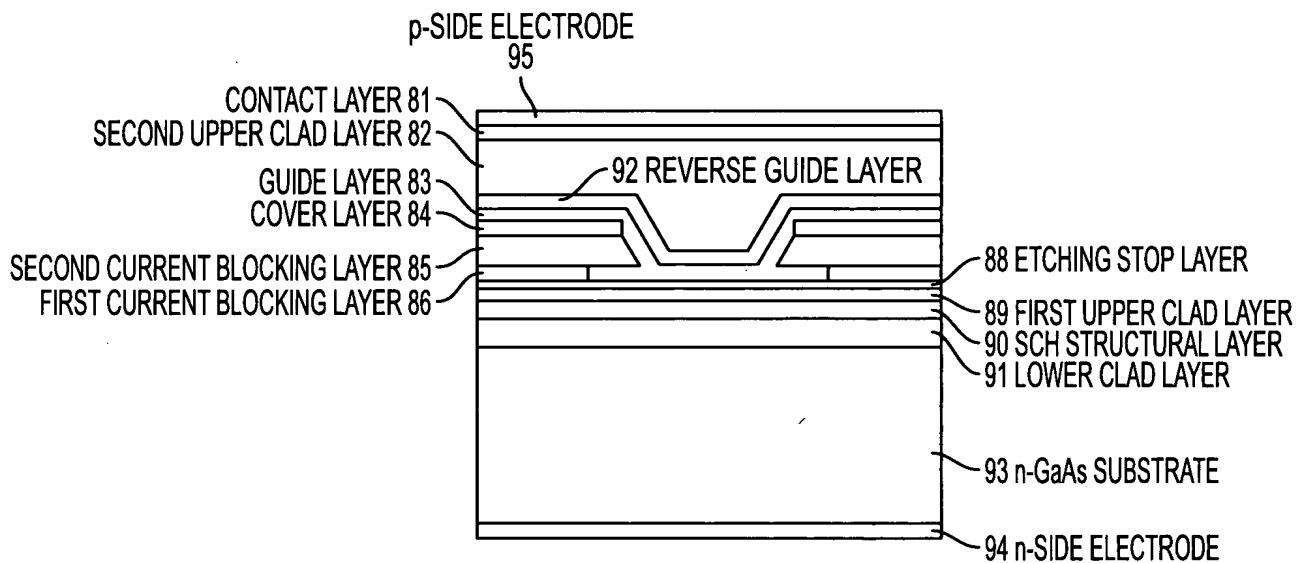
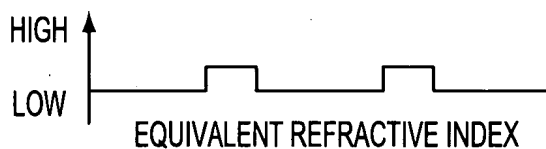
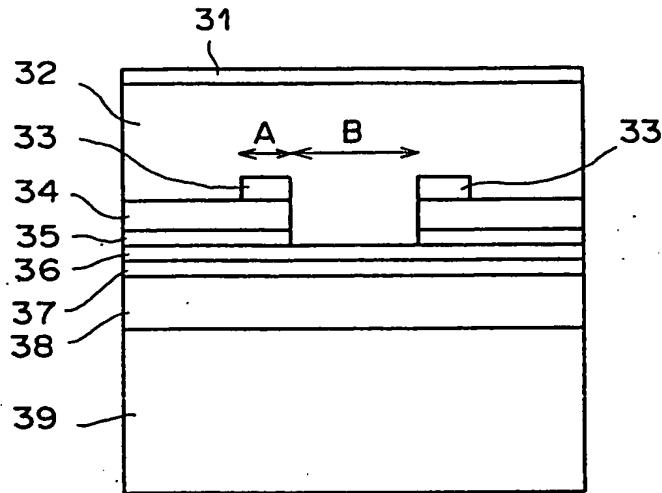


FIG. 13B



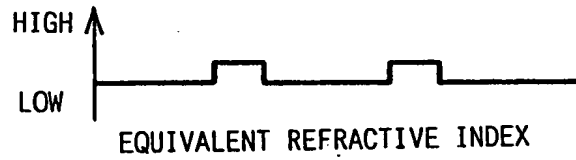


F I G . 18A



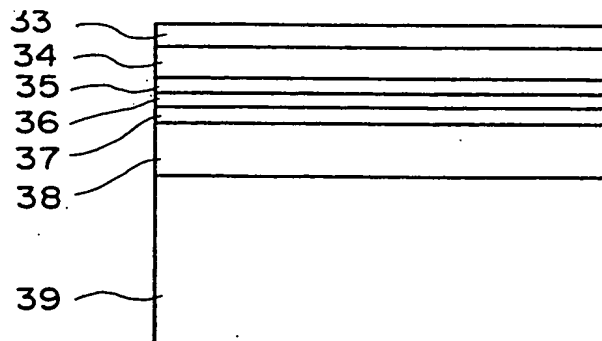
PRIOR ART

F I G . 18B



PRIOR ART

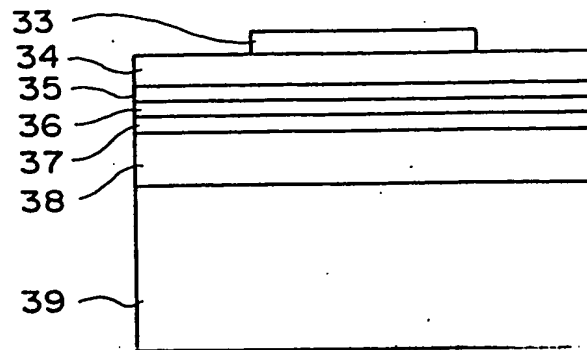
F I G . 19



PRIOR ART

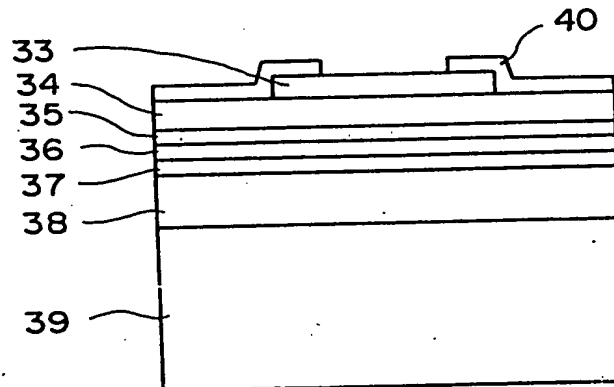


F I G . 20



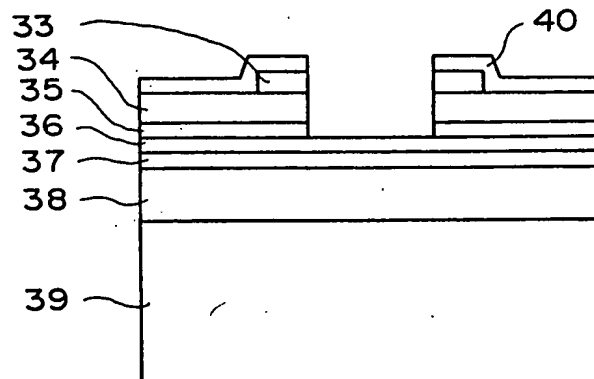
PRIOR ART

F I G . 21



PRIOR ART

F I G . 22



PRIOR ART